

# BLM9D2527-09AM

LDMOS 2-stage integrated Doherty MMIC

Rev. 2 — 8 February 2021

AMPLEON

Product data sheet

## 1. Product profile

### 1.1 General description

The BLM9D2527-09AM is a 2-stage 9 W fully integrated Doherty MMIC solution using Ampleon's state of the art GEN9 LDMOS technology. The carrier and peaking device, input splitter and output combiner are integrated in a single package. This multiband device is perfectly suited as a device in the frequency range from 2496 MHz to 2700 MHz. Available in LGA outline.

**Table 1. Performance**

Typical RF performance at  $T_{case} = 25^\circ\text{C}$ ;  $I_{Dq} = 20 \text{ mA}$  (driver and final stages) in a demo circuit;  $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.55 \text{ V}$ .

Test signal	f (MHz)	$V_{DS}$ (V)	$P_{L(AV)}$ (W)	$G_p$ (dB)	$\eta_D$ (%)	$\text{ACPR}_{5\text{M}}$ (dBc)
single carrier W-CDMA [1]	2600	28	1.26	26.7	41	-33

[1] Test signal: 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF.

### 1.2 Features and benefits

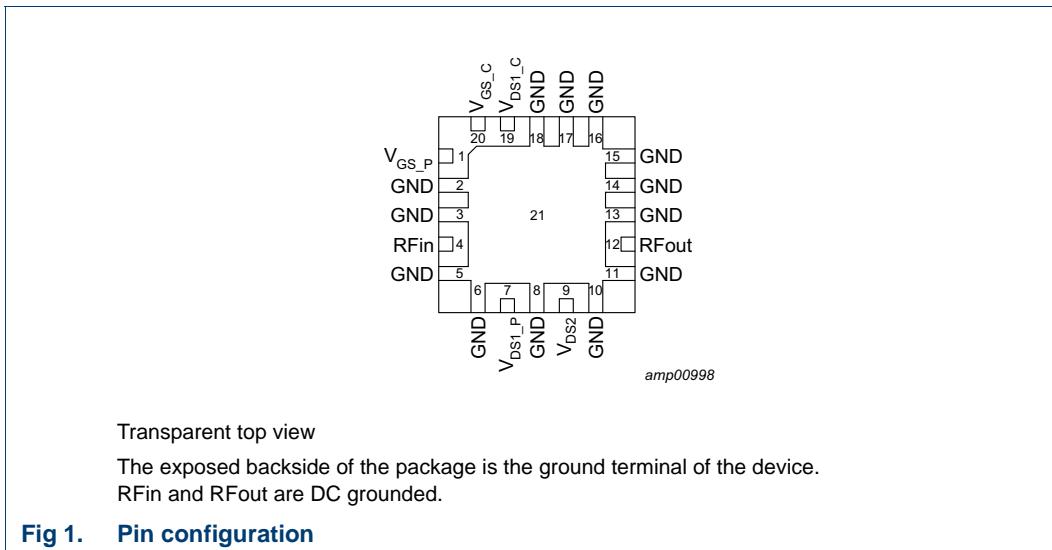
- Integrated input splitter
- Integrated output combiner
- Very high efficiency
- Designed for broadband operation (frequency 2496 MHz to 2700 MHz)
- Independent control of carrier and peaking bias
- Integrated ESD protection
- Excellent thermal stability
- High power gain, input and output matched to impedance  $50 \Omega$
- For RoHS compliance see the product details on the Ampleon website

### 1.3 Applications

- RF power MMIC for multi-carrier and multi-standard GSM, W-CDMA, LTE and NR small cell base stations in the 2496 MHz to 2700 MHz frequency range

## 2. Pinning information

### 2.1 Pinning



### 2.2 Pin description

**Table 2. Pin description**

Symbol	Pin	Description
V <sub>GS_P</sub>	1	gate-source voltage of peaking
GND	2	ground
GND	3	ground
RFIn	4	RF input
GND	5	ground
GND	6	ground
V <sub>DS1_P</sub>	7	drain-source voltage of peaking driver
GND	8	ground
V <sub>DS2</sub>	9	drain-source voltage of final stages
GND	10	ground
GND	11	ground
RFout	12	RF output
GND	13	ground
GND	14	ground
GND	15	ground
GND	16	ground
GND	17	ground
GND	18	ground

**Table 2.** Pin description ...continued

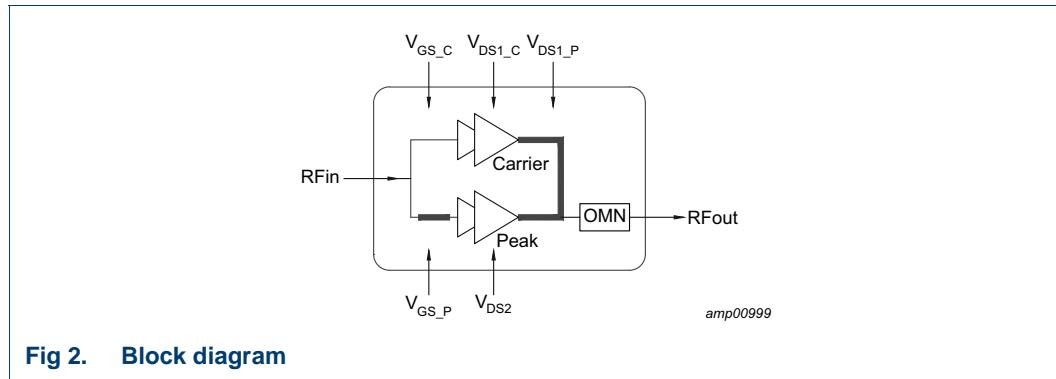
Symbol	Pin	Description
V <sub>DS1_C</sub>	19	drain-source voltage of carrier driver
V <sub>GS_C</sub>	20	gate-source voltage of carrier driver
GND	21	RF ground

### 3. Ordering information

**Table 3.** Ordering information

Type number	Package		
	Name	Description	Version
BLM9D2527-09AM	-	plastic thermal enhanced package; no leads; 20 terminals; body 7.0 x 7.0 x 0.98 mm	LGA-7x7-20-1

### 4. Block diagram



### 5. Limiting values

**Table 4.** Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage		-	65	V
V <sub>GS</sub>	gate-source voltage		-6	+11	V
T <sub>stg</sub>	storage temperature		-55	+125	°C
T <sub>j</sub>	junction temperature	[1]	-	175	°C
T <sub>case</sub>	case temperature	[1]	-	125	°C

[1] Continuous use at maximum temperature will affect the reliability. For details refer to the online MTF calculator.

## 6. Thermal characteristics

**Table 5. Thermal characteristics**

Measured for total device.

Symbol	Parameter	Conditions	Value	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	$T_{case} = 80 \text{ }^{\circ}\text{C}$ ; $P_{L(AV)} = 1.26 \text{ W}$	[1] 9.1	K/W
		$T_{case} = 80 \text{ }^{\circ}\text{C}$ ; $P_{L(AV)} = 2 \text{ W}$	[1] 8.2	K/W

[1] When operated with a 1-carrier W-CDMA with PAR = 7.2 dB.

## 7. Characteristics

**Table 6. DC characteristics**

$T_{case} = 25 \text{ }^{\circ}\text{C}$ ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Carrier</b>						
$V_{GSq}$	gate-source quiescent voltage	$V_{DS} = 28 \text{ V}$ ; $I_D = 20 \text{ mA}$	1.65	2.09	2.75	V
$I_{GSS}$	gate leakage current	$V_{GS} = 11 \text{ V}/-5 \text{ V}$ ; $V_{DS} = 0 \text{ V}$	-	-	140	nA
<b>Peaking</b>						
$I_{GSS}$	gate leakage current	$V_{GS} = 11 \text{ V}/-5 \text{ V}$ ; $V_{DS} = 0 \text{ V}$	-	-	140	nA
<b>Final stages</b>						
$I_{DSS}$	drain leakage current	$V_{GS} = 0 \text{ V}$ ; $V_{DS} = 60 \text{ V}$	-	-	1.4	$\mu\text{A}$
<b>Driver stages</b>						
$I_{DSS}$	drain leakage current	$V_{GS} = 0 \text{ V}$ ; $V_{DS} = 60 \text{ V}$	-	-	1.4	$\mu\text{A}$

**Table 7. RF Characteristics**

Typical RF performance at  $T_{case} = 25 \text{ }^{\circ}\text{C}$ ;  $V_{DS} = 28 \text{ V}$ ;  $I_{Dq} = 20 \text{ mA}$  (carrier);  $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.55 \text{ V}$ ;  $f = 2.7 \text{ GHz}$ . Unless otherwise specified, measured in an Ampleon production circuit.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Test signal: CW pulsed</b>						
$G_p$	power gain	$P_L = 1.26 \text{ W}$	25	26.5	28.0	dB
$\eta_D$	drain efficiency	$P_L = 1.26 \text{ W}$	41	46.6	-	%
$RL_{in}$	input return loss	$P_L = 1.26 \text{ W}$	-	-22.6	-15	dB
$P_{L(3dB)}$	output power at 3 dB gain compression		39	40	-	dBm

## 8. Application information

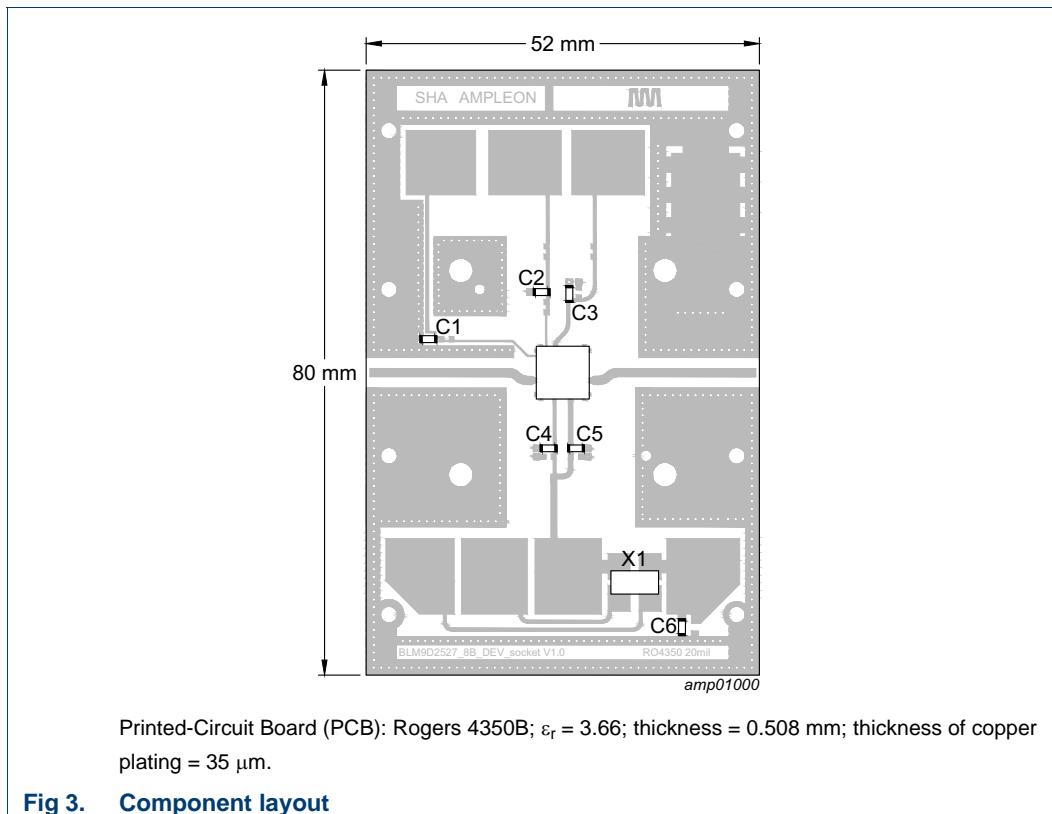
**Table 8. Typical performance**

Test signal: 1-carrier W-CDMA;  $T_{case} = 25^\circ\text{C}$ ;  $V_{DS} = 28\text{ V}$ ;  $I_{Dq} = 20\text{ mA}$  (driver and final stages); test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability CCDF; unless otherwise specified, measured in an Ampleon 2496 MHz to 2690 MHz frequency band demo circuit.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$P_{L(3dB)}$	output power at 3 dB gain compression	$f = 2600\text{ MHz}$ [1]	-	40	-	dBm
$\eta_D$	drain efficiency	$9\text{ dB OBO } (P_{L(AV)} = 31\text{ dBm})$ ; $f = 2600\text{ MHz}$	-	41	-	%
$G_p$	power gain	$P_{L(AV)} = 31\text{ dBm}; f = 2600\text{ MHz}$	-	26.7	-	dB
$G_{flat}$	gain flatness	$P_{L(AV)} = 31\text{ dBm}; f = 2496\text{ MHz to } 2690\text{ MHz}$	-	0.8	-	dB
$\text{ACPR}_{5\text{M}}$	adjacent channel power ratio (5M)	$P_{L(AV)} = 31\text{ dBm}; f = 2600\text{ MHz}$	-	-33	-	dBc
$\Delta G/\Delta T$	gain variation with temperature	$f = 2600\text{ MHz}$	-	0.04	-	dB/ $^\circ\text{C}$
K	Rollett stability factor	$T_{case} = -40^\circ\text{C}; f = 0.15\text{ GHz to } 5\text{ GHz}$ [2]	-	>1.7	-	

[1] Pulsed CW power sweep measurement ( $\delta = 10\%$ ,  $t_p = 100\text{ }\mu\text{s}$ ).

[2] S-parameters measured in a demo circuit.

**Table 9. Demo test circuit list of components**See [Figure 3](#) for component layout.

Component	Description	Value	Remarks
C1, C2, C3, C4, C5	multilayer ceramic chip capacitor	1 $\mu\text{F}$	[1]
C6	multilayer ceramic chip capacitor	1 $\mu\text{F}$	[2]
X1	current sense resistor	100 m $\Omega$ , 1 W	Y44870R10000B0R

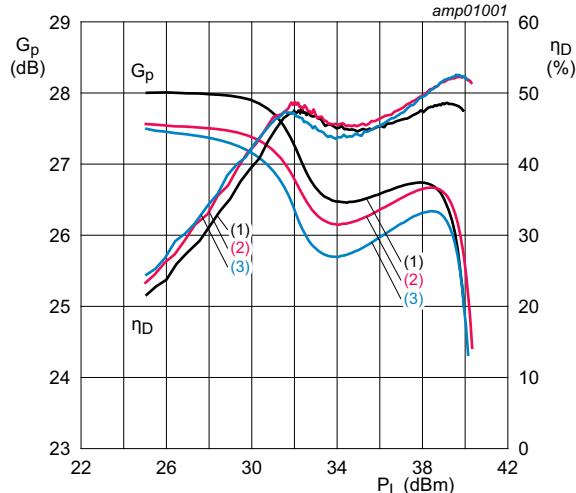
[1] American Technical Ceramics type 600F or capacitor of same quality.

[2] Murata or capacitor of same quality.

## 8.1 Ruggedness in a Doherty operation

The BLM9D2527-09AM is capable of withstanding a load mismatch corresponding to  $VSWR = 10 : 1$  through all phases under the following conditions:  $V_{DS} = 28$  V;  $I_{Dq} = 20$  mA (carrier);  $V_{GSq(\text{peaking})} = V_{GSq(\text{carrier})} - 0.55$  V;  $P_i$  corresponding to  $P_{L(3\text{dB})}$  under  $Z_S = 50 \Omega$  load;  $f = 2500$  MHz (CW);  $T_{\text{case}} = 25^\circ\text{C}$ .

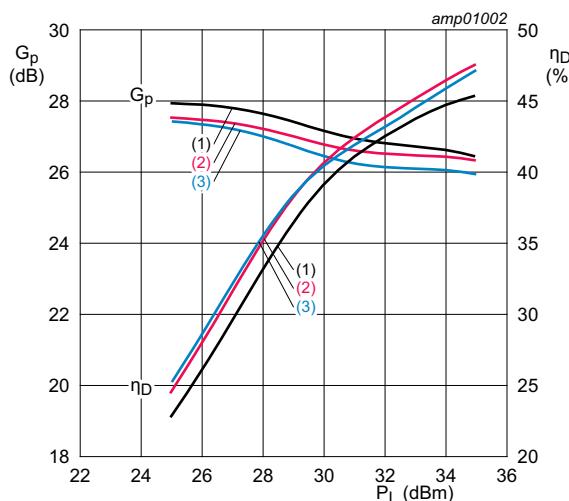
## 8.2 Graphs



$V_{DS} = 28$  V;  $V_{GS(amp)peak} = V_{GS(amp)main} - 0.55$  V;  
 $I_{Dq} = 20$  mA;  $t_p = 100$   $\mu$ s;  $\delta = 10$  %.

- (1)  $f = 2500$  MHz
- (2)  $f = 2600$  MHz
- (3)  $f = 2700$  MHz

**Fig 4. Power gain and drain efficiency as function of output power; typical values**

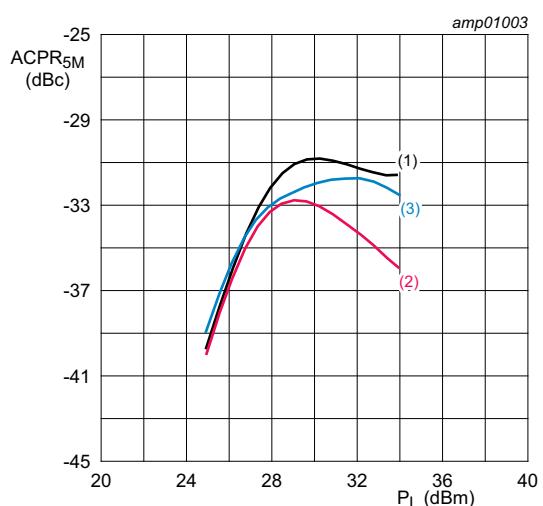


$V_{DS} = 28$  V;  $V_{GS(amp)peak} = V_{GS(amp)main} - 0.55$  V;  
 $I_{Dq} = 20$  mA.

Test signal: 1-carrier W-CDMA; 3GPP test model 1;  
64 DPCH; PAR = 7.2 dB at 0.01 % probability CCDF.

- (1)  $f = 2500$  MHz
- (2)  $f = 2600$  MHz
- (3)  $f = 2700$  MHz

**Fig 5. Power gain and drain efficiency as function of output power; typical values**

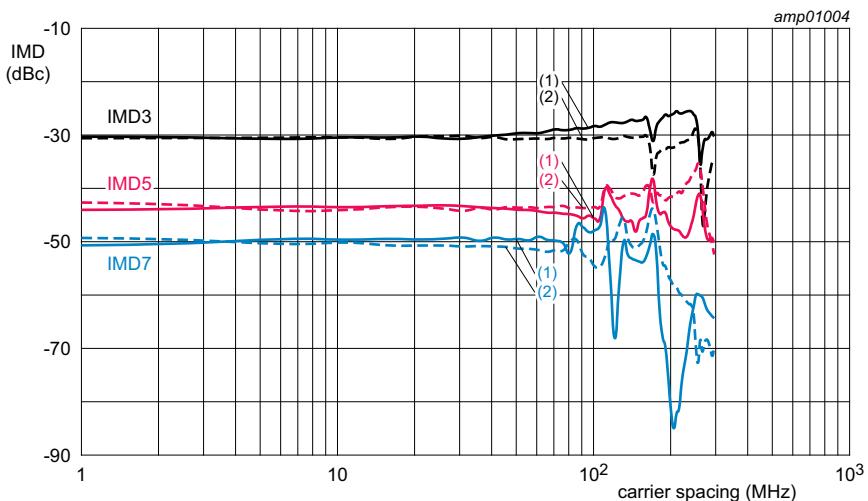


$V_{DS} = 28$  V;  $V_{GS(amp)peak} = V_{GS(amp)main} - 0.55$  V;  $I_{Dq} = 20$  mA.

Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability CCDF.

- (1)  $f = 2500$  MHz
- (2)  $f = 2600$  MHz
- (3)  $f = 2700$  MHz

**Fig 6. Adjacent channel power ratio as a function of output power; typical values**



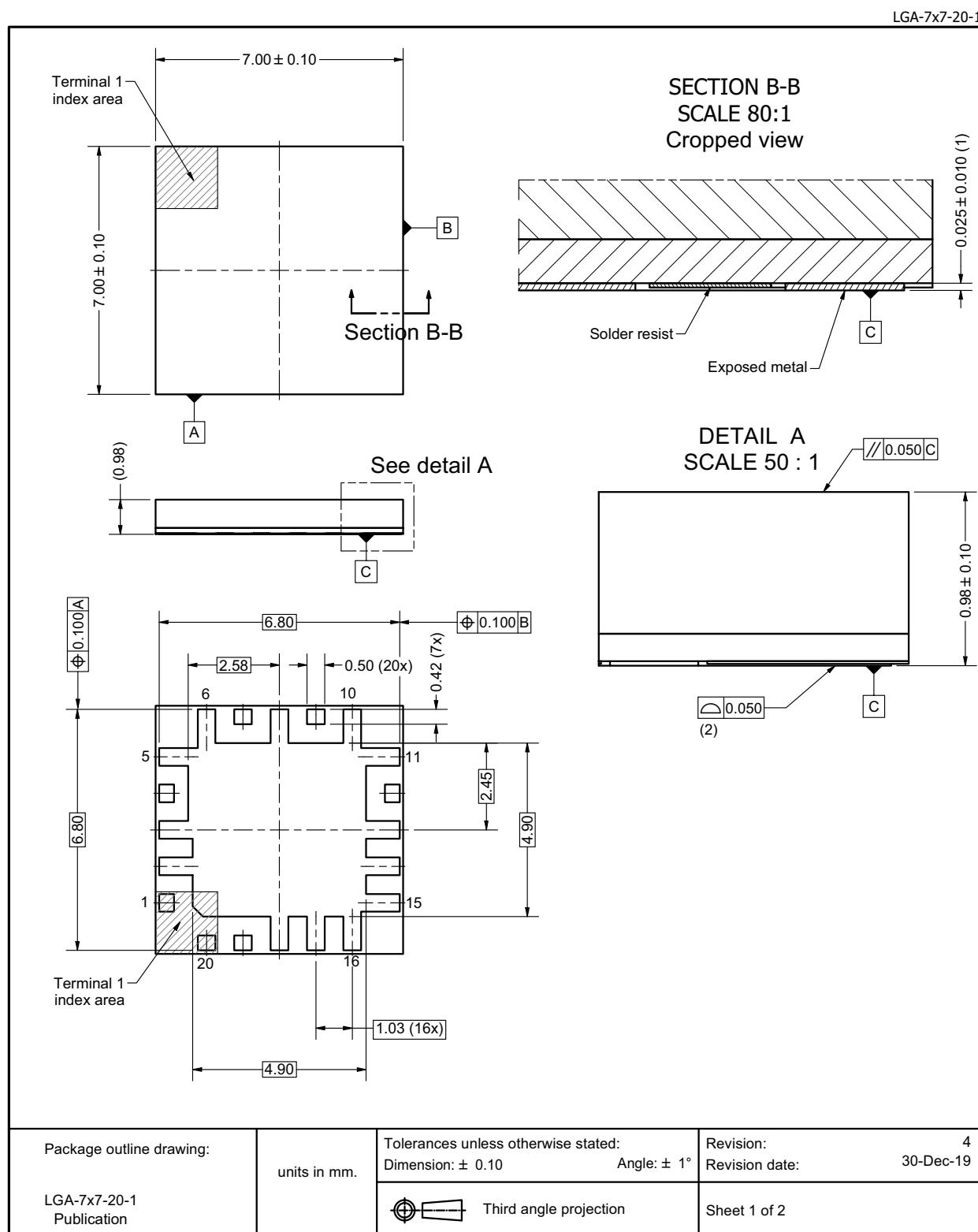
$V_{DS} = 28$  V;  $V_{GS(amp)peak} = V_{GS(amp)main} - 0.55$  V;  $I_{Dq} = 20$  mA;  $f = 2600$  MHz.

Test signal: 2-carrier pulsed CW;  $t_p = 100$   $\mu$ s;  $\delta = 10$  %.

- (1) IMD low
- (2) IMD high

**Fig 7. VBW capability**

## 9. Package outline



**Fig 8. Package outline LGA-7x7-20-1 (sheet 1 of 2)**

LGA-7x7-20-1

Drawing Notes	
Item	Description
1	Metal thickness of solder pads.
2	Flatness with respect to exposed metal

Package outline drawing:  LGA-7x7-20-1	units in mm.	Tolerances unless otherwise stated: Dimension: $\pm 0.10$ Angle: $\pm 1^\circ$   Third angle projection	Revision: 4 Revision date: 30-Dec-19  Sheet 2 of 2
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Fig 9. Package outline LGA-7x7-20-1 (sheet 2 of 2)

## 10. Handling information

### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A* or equivalent standards.

**Table 10. ESD sensitivity**

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C2A <a href="#">[1]</a>
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	1C <a href="#">[2]</a>

[1] CDM classification C2A is granted to any part that passes after exposure to an ESD pulse of 500 V.

[2] HBM classification 1C is granted to any part that passes after exposure to an ESD pulse of 1000 V.

## 11. Abbreviations

**Table 11. Abbreviations**

Acronym	Description
3GPP	3rd Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCCH	Dedicated Physical CHannel
ESD	ElectroStatic Discharge
GEN9	Ninth Generation
GSM	Global System for Mobile Communications
LDMOS	Laterally Diffused Metal Oxide Semiconductor
LTE	Long Term Evolution
MMIC	Monolithic Microwave Integrated Circuit
MTF	Median Time to Failure
NR	New Radio
OBO	Output Back Off
PAR	Peak-to-Average Ratio
RoHS	Restriction of Hazardous Substances
VBW	Video BandWidth
VSWR	Voltage Standing-Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

## 12. Revision history

**Table 12. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLM9D2527-09AM v.2	20210208	Product data sheet	-	BLM9D2527-09AM v.1
Modifications			<ul style="list-style-type: none"><li>• <a href="#">Section 1.1 on page 1</a>: changed 2500 MHz to 2496 MHz</li><li>• <a href="#">Section 1.2 on page 1</a>: changed 2500 MHz to 2496 MHz</li><li>• <a href="#">Section 1.3 on page 1</a>: changed 2500 MHz to 2496 MHz</li><li>• <a href="#">Table 6 on page 4</a>: table updated</li><li>• <a href="#">Table 7 on page 4</a>: table updated</li><li>• <a href="#">Figure 6 on page 8</a>: figure notes updated</li><li>• <a href="#">Section 9 on page 9</a>: package outline drawing updated</li></ul>	
BLM9D2527-09AM v.1	20190823	Product data sheet	-	-

## 13. Legal information

### 13.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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